DISCRETE SEMICONDUCTORS

DATA SHEET

BYW29EX series Rectifier diodes ultrafast, rugged

Product specification

September 2018



Rectifier diodes ultrafast, rugged

BYW29EX series

GENERAL DESCRIPTION

QUICK REFERENCE DATA

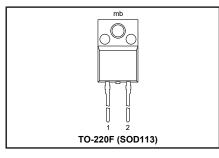
Glass passivated epitaxial rectifier diodes in a full pack plastic envelope, featuring low forward voltage drop, ultra-fast recovery times, soft recovery characteristic and guaranteed reverse surge and ESD capability. They are intended for use in switched mode power supplies and high frequency circuits in general where low conduction and switching losses are essential.

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V_{RRM}	BYW29EX- Repetitive peak reverse	150 150	200 200	V
$egin{array}{c} V_{F} \ I_{F(AV)} \ t_{rr} \ I_{RRM} \end{array}$	voltage Forward voltage Forward current Reverse recovery time Repetitive peak reverse current	0.895 8 25 0.2	0.895 8 25 0.2	V A ns A

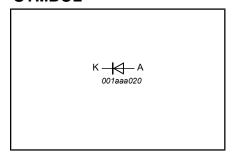
PINNING - SOD113

DESCRIPTION	
cathode	
anode	
isolated	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage			-150 150 150 150	-200 200 200 200	V V V
I _{F(AV)}	Average forward current ¹	square wave; δ = 0.5; $T_{hs} \le 106 ^{\circ}\text{C}$ sinusoidal; a = 1.57; $T_{hs} \le 109 ^{\circ}\text{C}$	-	{ 7	.3	A A
I _{F(RMS)}	RMS forward current Repetitive peak forward current		- -	11	-	A
I _{FSM}	Non-repetitive peak forward current	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-	8 8		A A
I ² t I _{RRM} I _{RSM}	I I tior lusing	$\begin{array}{l} V_{\text{RWM(max)}} \\ t = 10 \text{ ms} \\ t_p = 2 \mu\text{s}; \ \delta = 0.001 \\ t_p = 100 \mu\text{s} \end{array}$	-	3 0. 0.	.2	A ² s A A
${\mathsf T}_{stg} \atop {\mathsf T}_{\mathsf j}$	Storage temperature Operating junction temperature		-40 -		50 50	°C °C

¹ Neglecting switching and reverse current losses

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ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _C	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 kΩ	-	8	kV

ISOLATION LIMITING VALUE & CHARACTERISTIC

T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from both terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-		2500	V
C _{isol}	Capacitance from both terminals to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	Thermal resistance junction to heatsink	with heatsink compound	-	-	5.5	K/W K/W
R _{th j-a}	1 11 2 2 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3 3	without heatsink compound in free air	-	55	-	K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{F}	Forward voltage	$I_F = 8 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.80	0.895	V
		$I_F = 8 \text{ A}$	-	0.92	1.05	V
		$I_{\rm F} = 20 \text{ A}$	-	1.1	1.3	V
l _R	Reverse current	$V_R = V_{RWM}$; $T_j = 100 ^{\circ}C$	-	0.2	0.6	mΑ
		$V_{R} = V_{RWM}$	-	2	10	μΑ

DYNAMIC CHARACTERISTICS

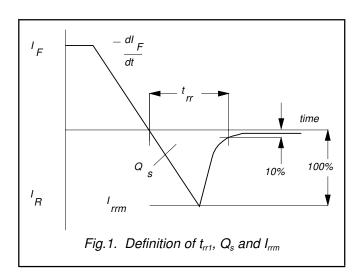
T_i = 25 °C unless otherwise stated

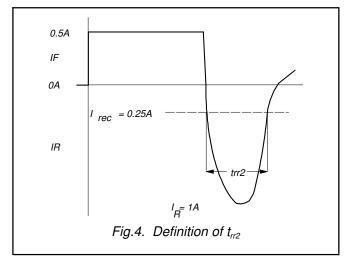
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q_s	Reverse recovery charge	$I_{E} = 2 \text{ A}; V_{B} \ge 30 \text{ V}; -dI_{E}/dt = 20 \text{ A}/\mu\text{s}$	-	4	11	nC
t _{rr1}	Reverse recovery time	$I_F = 1 \text{ A}; V_R \ge 30 \text{ V};$ - $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	20	25	ns
t _{rr2}	Reverse recovery time	$ I_F = 0.5 \text{ A to } I_R = 1 \text{ A}, I_{rec} = 0.25 \text{ A}$	-	15	20	ns
$V_{\rm fr}$	Forward recovery voltage	$I_F = 1 \text{ A}; dI_F/dt = 10 \text{ A/µs}$	-	1	-	V

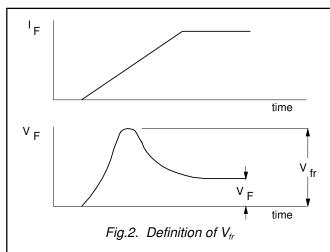
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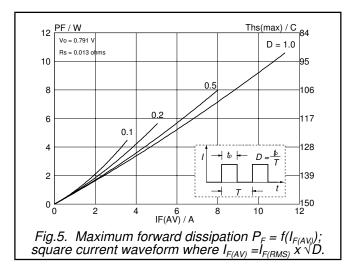
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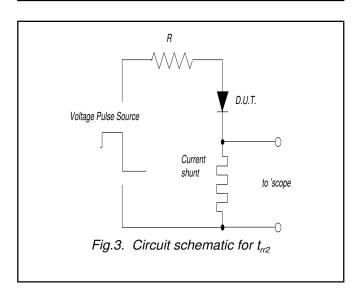
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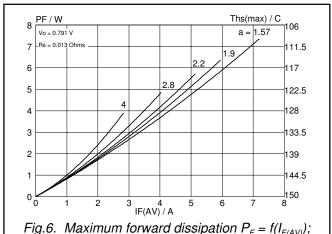
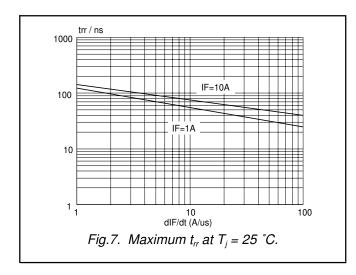


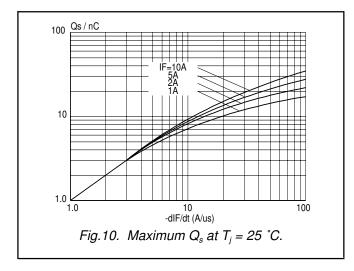
Fig.6. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where a = form factor $= I_{F(RMS)} / I_{F(AV)}$.

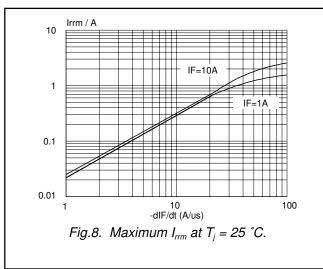
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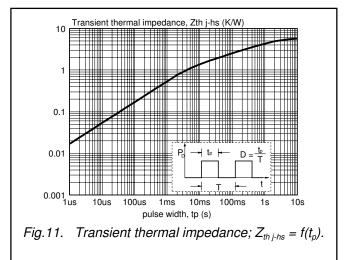
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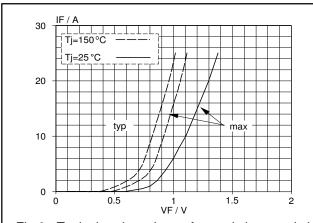


Fig.9. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

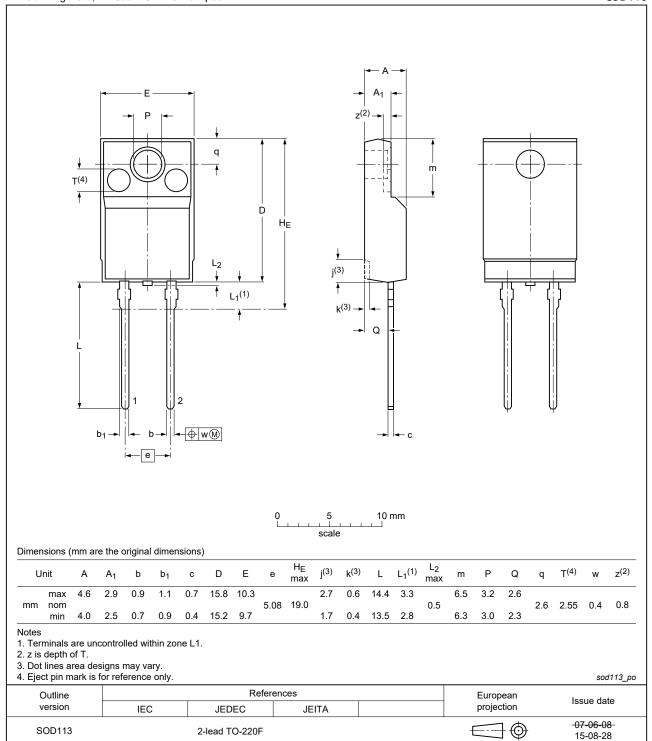
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MECHANICAL DATA

Plastic single- ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO- 220 'full pack'

SOD113



Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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